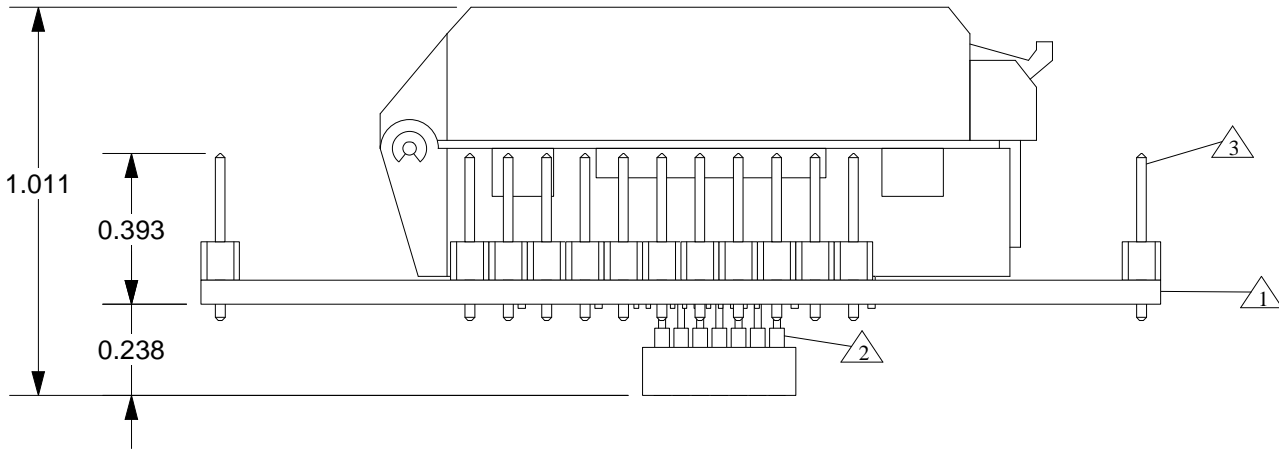


Top View




Side View

- ① Substrate: 0.0625"±0.007" FR4/G10 or equivalent high temp material. 1/2 oz. Cu clad. SnPb plating
- ② Pins: shell material- Brass Alloy 360 1/2 hard; finish- 10µ" Au over 50µ" Nil (min.). Contact material- BeCu; finish 10µ" Au over 100µ" Ni (min.)
- ③ Test points: material- Phosphor Bronze; plating- Sn over 50µ" Ni. Gold flash on contact end.

Description: Carrier Adaptor

44 position QFP Carrier Adaptor to mini grid. Package specs: 12mm tip to tip, 10mm body, 0.8mm pitch.

All tolerances: ±0.005" (unless stated otherwise). Materials and specifications are subject to change without notice.

	CA-QFE44SE-M-Z-T-01 Drawing	Status: Released	Scale: 2:1	Rev: A
	© 1999 IRONWOOD ELECTRONICS, INC. PO BOX 21151 ST. PAUL, MN 55121 Tele: (651) 452-8100 www.ironwoodelectronics.com	Drawing: W. Watson	Date: 11/24/99	
		File: CA-QFE44SE-M-Z-T-01 Dwg	Modified:	